

# **Product Compliance Declaration**

Please see <a href="https://www.molex.com">www.molex.com</a> for the most up-to-date information.

#### **Contact Information**

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

### **Part Information**

Part Number 0022022105 Part Weight 1.049G

Part Name KK 100 PCB Assy Top 10 Ckt Tin

#### **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
KK 100 PCB Assy Top 10 Ckt Tin	Assembly		100	1.049	
KK 100 HOUSING PC TAIL 10 CKT	Component		68.5415	0.719	
PA66 UF WHITE	Material		68.5415	0.719	
PA66	Substance		58.2602	0.61115	
Further Additives	Substance	system	3.4271	0.03595	
Flame Retardant, ISO 1043-4 FR(30)	Substance		6.8541	0.0719	
KK 100 TERMINAL PC TAIL TIN	Component		31.4585	0.33	
Cartridge Brass 70%	Material		31.4585	0.33	
Cartridge Brass 70% Unplated	Material		30.4173	0.319077	
Copper	Substance	7440-50-8	21.2921	0.223354	
Zinc (metal)	Substance	7440-66-6	9.1252	0.095723	
Tin Plating	Material		1.0412		
Tin	Substance	7440-31-5	1.0412	0.010923	

#### Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

#### **ROHS Declaration Information**

Regulatory Revision 2011/65/EU

Compliance Status Compliant

**Contained Substances Exceeding Threshold** 

None

**Exemptions** 

None

#### **REACH-SVHC Declaration Information**

Regulatory Revision ED/61/2018 (27 June 2018)

**Contained Substances Exceeding Threshold** 

None

#### **GADSL Declaration Information**

Regulatory Revision GADSL imported from IMDS

## **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	150	Yes
Copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes

<sup>\*</sup>Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

#### **Exemptions**

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits

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#### **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

#### **Contained Substances Exceeding Threshold**

None

#### **China ROHS Declaration Information**

Part Number 0022022105							
Part Name KK 100 PCB Assy Top 10 Ckt Tin	<b>(e)</b>						
Part Information			Ha	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
KK 100 PCB Assy Top 10 Ckt Tin		0	0	0	0	0	0
KK 100 HOUSING PC TAIL 10 CKT		0	0	0	0	0	0
KK 100 TERMINAL PC TAIL TIN		0	0	0	0	0	0

#### **Process Information**

Component Plating / Surface Finish	BSn
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	005
Maximum Process Temperature (C)	235
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	N/A

Oct 11, 2018